

Features

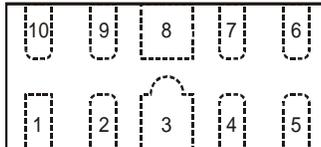
- IEC 61000-4-2 (ESD): Air – ±18kV, Contact – ±18kV
- 4 Channels of ESD Protection
- Low Channel Input Capacitance of 0.4pF Typical
- Typically Used at High-Speed Ports such as USB 2.0, USB 3.0, IEEE1394, Serial ATA, DVI, HDMI, PCI
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. “Green” Device (Note 3)**
- **The D5V0X4U10LPQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.**

<https://www.diodes.com/quality/product-definitions/>

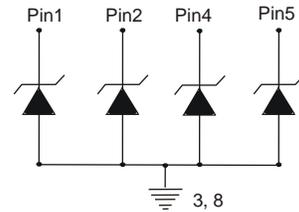
Mechanical Data

- Package: U-DFN2510-10
- Package Material: Molded Plastic, “Green” Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe (Lead-Free Plating). Solderable per MIL-STD-202, Method 208 ^(e4)
- Weight: 0.039 grams (Approximate)

Pin#	Description
1, 2, 4, 5	Input
6, 7, 9, 10	No Connection
3, 8	Ground



Pin Description (Top View)



Device Schematic

Ordering Information (Note 4)

Orderable Part Number	Package	Marking	Reel Size (inches)	Tape Width (mm)	Packing	
					Qty.	Carrier
D5V0X4U10LPQ-7	U-DFN2510-10	MU3	7	8	3,000	Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



MU3 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: L = 2024)
 M = Month (ex: 9 = September)

Date Code Key

Year	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034	2035
Code	L	M	N	P	R	S	T	U	V	W	X	Y

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	I _{PP}	4.0	A	8/20μs, Figure 3
ESD Protection – Contact Discharge	V _{ESD_Contact}	±18	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V _{ESD_Air}	±18	kV	Standard IEC 61000-4-2

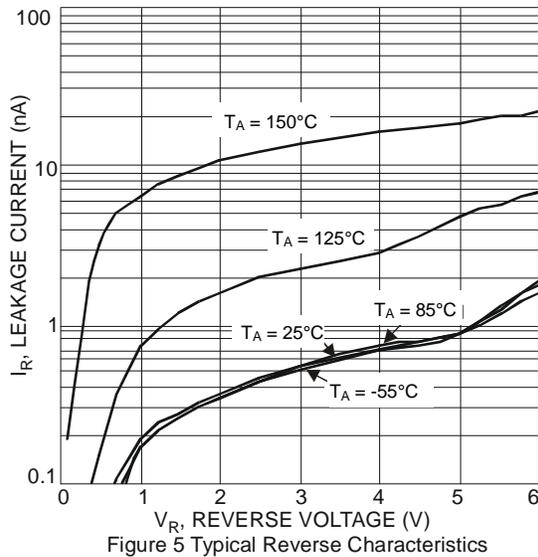
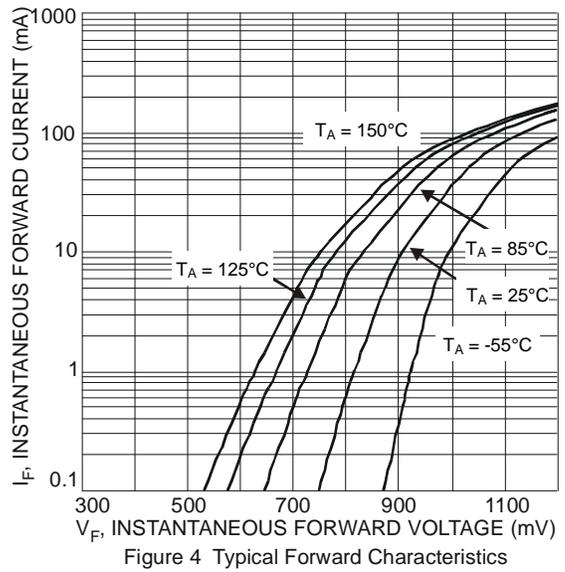
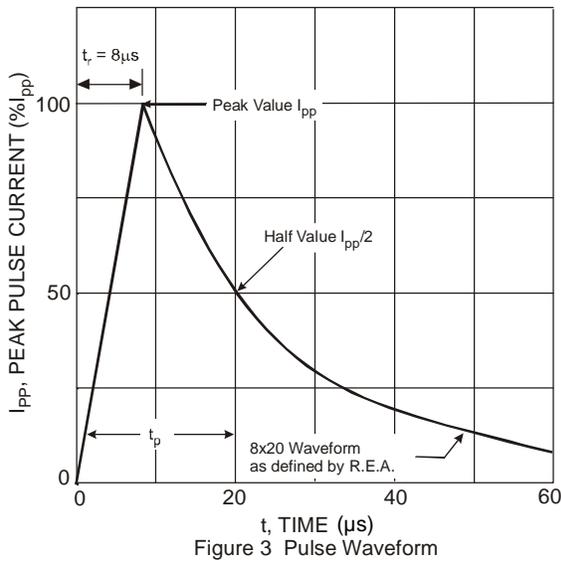
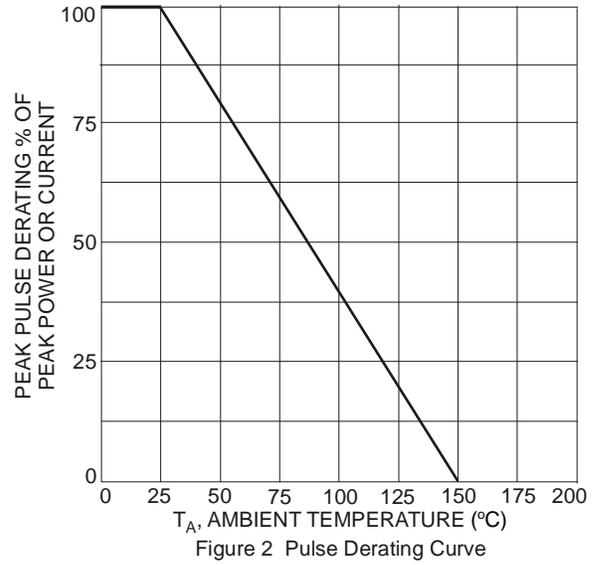
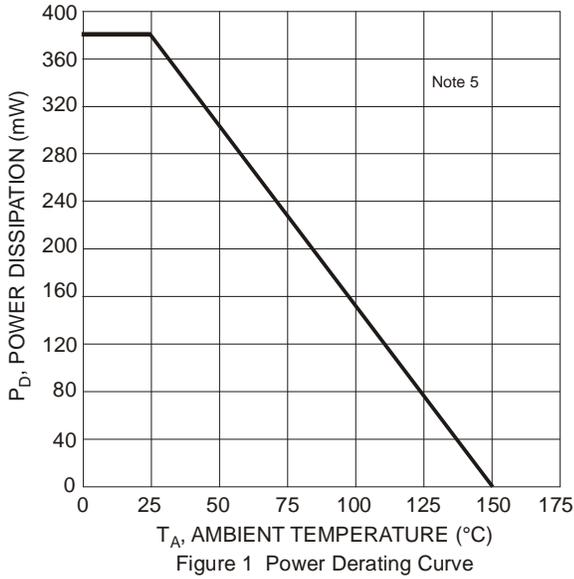
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	380	mW
Thermal Resistance, Junction to Ambient, T _A = +25°C	R _{θJA}	327	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Working Voltage	V _{RWM}	—	—	5.0	V	—
Reverse Current (Note 6)	I _R	—	—	100	nA	V _R = 5.0V
Reverse Breakdown Voltage	V _{BR}	5.5	—	—	—	I _R = 1mA, I _O to I _O
Reverse Clamping Voltage, Positive Transients (Note 7)	V _{CL}	—	—	10	V	I _{PP} = 1A, t _P = 8/20μs
		—	—	13	V	I _{PP} = 3A, t _P = 8/20μs
Dynamic Resistance	R _{DYN}	—	1.0	—	Ω	I _R = 1A, t _P = 8/20μs
Channel Input Capacitance	C _T	—	0.4	0.5	pF	V _R = 0V, f = 1MHz

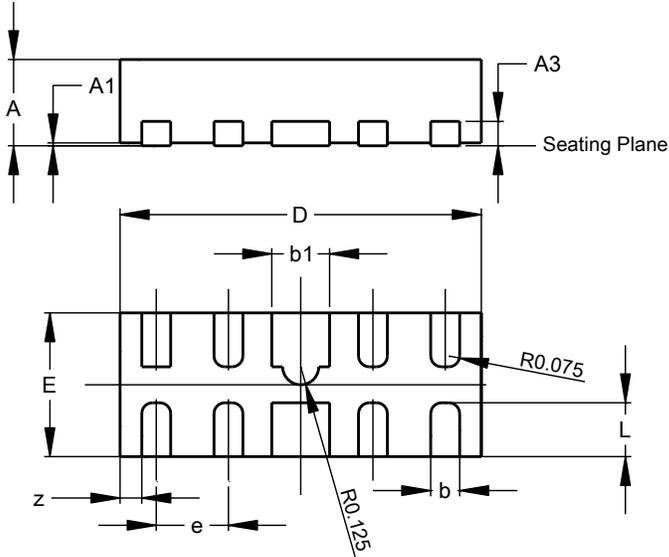
- Notes:
5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
 6. Short duration pulse test used to minimize self-heating effect.
 7. Clamping voltage value is based on an 8 x 20μs peak pulse current (I_{pp}) waveform.



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

U-DFN2510-10

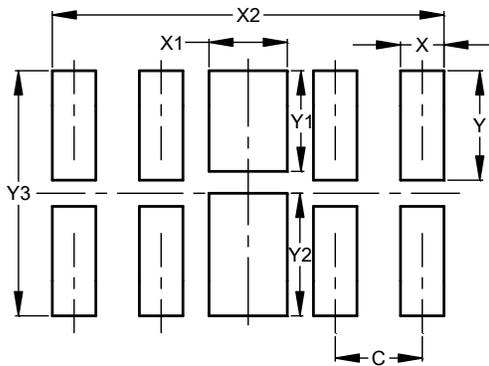


U-DFN2510-10			
Dim	Min	Max	Typ
A	0.545	0.605	0.575
A1	0.00	0.05	0.03
A3	-	-	0.13
b	0.15	0.25	0.20
b1	0.35	0.45	0.40
D	2.450	2.575	2.500
e	-	-	0.50
E	0.950	1.075	1.000
L	0.325	0.425	0.375
z	-	-	0.150
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

U-DFN2510-10



Dimensions	Value (in mm)
C	0.500
X	0.250
X1	0.450
X2	2.250
Y	0.625
Y1	0.575
Y2	0.700
Y3	1.400

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